



洲光源
CHAULIGHT

产品规格书 SPECIFICATION

客户名称: _____
Customer Name
产品类型: 红外接收头
Product Name
产品型号: ZSIRM-Z3B4N88P
Part No.

☐ 技术参考 Technical Reference		☐ 样品 Sample		☐ 量产供货 Mass Product	
客户审核（加盖公章） Client approval（Stamp）		洲光源审核 Chaulight approval			
核准 Approval	确认 Checked	核准 Approval	确认 Checked	制作 Edited	
		谢小金	杨培续	赖华棋	
☐ 接收 Qualified		☐ 不接收 Disqualified		日期 Date: 2022.08.14	

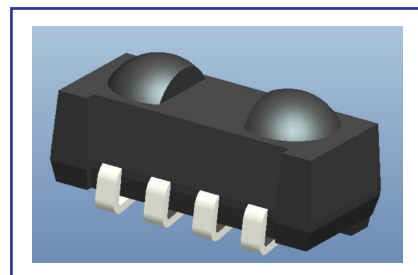
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ZSIRM-Z3B4N88P 是一种微型贴片封装红外接收器, 用于红外远程控制和其它需要改进抑制环境光或灯光的应用。单独的 PIN 光电二极管和前置放大器 IC 电路组装在单个引线框架上, 环氧树脂封装含有一个特殊的红外线过滤器及内置屏蔽抗干扰设计。

The ZSIRM-Z3B4N88P is a miniature patch packaged infrared receivers for infrared remote control and other remote control or reflection applications that requiring improved suppression of ambient light or lighting.

The individual PIN photo diode and preamplifier IC are assembled on a single lead frame. The epoxy resin package contains a special infrared filter and built-in shielding anti-interference design.



特性 Feature

--微型贴片封装

Micro patch packaging

--宽工作电压: 2.7~5.5V

Wide voltage operating

--宽半角和长接收距离

Wide half angle & long reception distance

--自动调制环境光偏置

Automatic modulation of ambient light bias

--内屏蔽设计, 抗光与电磁波干扰

Internal shielding design, resistant to light and electromagnetic interference

--兼容 TTL 和 COMS 电平, 低电平有效

Compatible with TTL and COMS outputs, effective at low levels

--低功耗

Low-power consumption

应用 Application

--电视,录像机,音响设备,空调,汽车立体声收音机,玩具,家庭电脑,所有需遥控设备

TV, VCR, audio equipment, air conditioning, car stereo radio, toys, home computer, all require remote control equipment

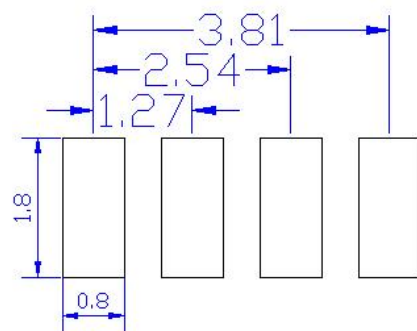
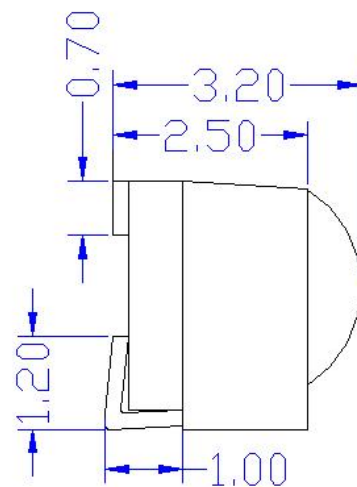
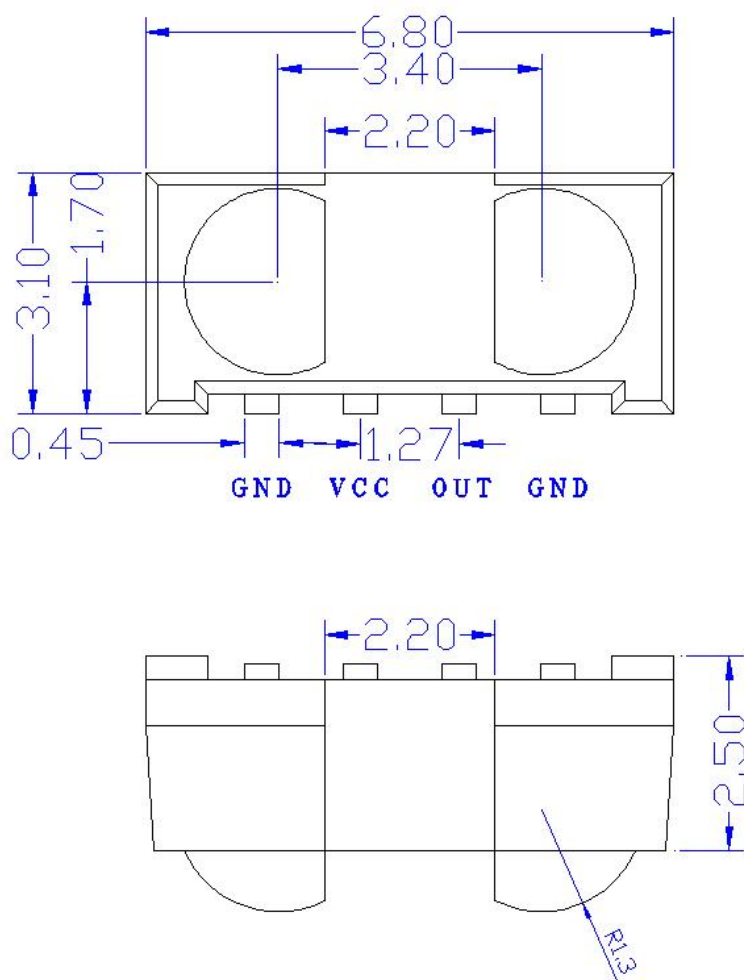
最大额定值 Absolute Maximum Ratings

测试项目 Parameter (Ta=25℃)	符合 Symbol	范围 Ratings	单位 Unit
电源电压 Supply voltage	Vcc	0-6	V
工作温度 Operating Temperature	Topr	-20~+80	℃
储存温度 Storage Temperature	Tstg	-25~+85	℃
焊接温度 Lead Soldering Temperature*2	Tsol	260 (<5s)	℃

*1、在 25 摄氏度的环境中测试 below 25 Free Air Temperature

*2、离胶体 2.5mm 以上焊接 5s 内 2.5mm form body for 5 seconds

产品尺寸 Package Dimension



推荐贴片焊盘尺寸

备注 Notes:

--所有尺寸为毫米标识

All dimensions are in millimeters

--未标识尺寸正负公差为 0.3mm

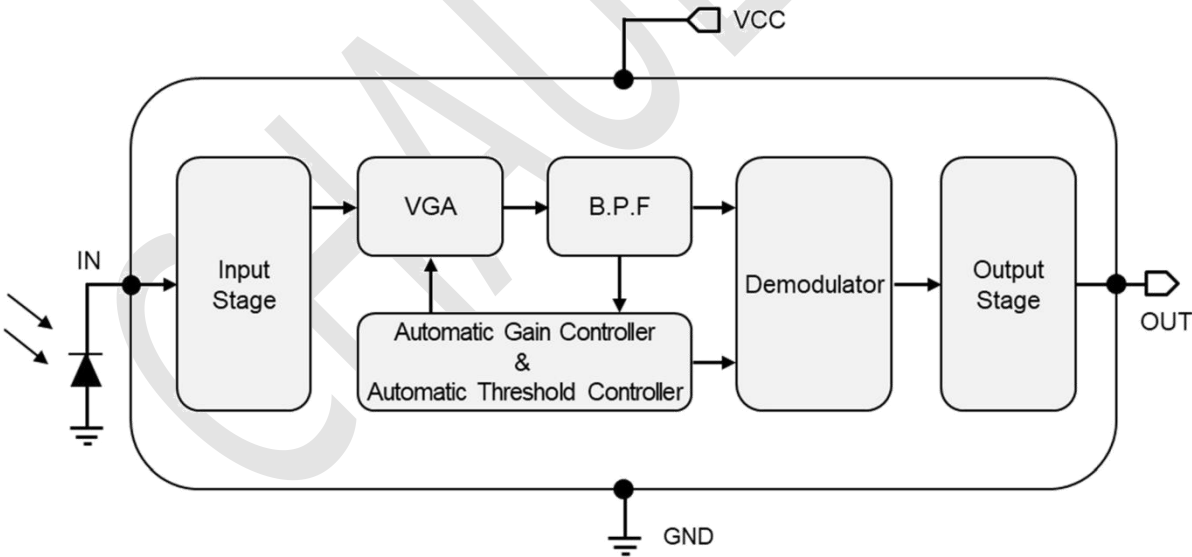
Tolerances unless dimensions $\pm 0.3\text{mm}$

光电特性 Electro-Optical Characteristics

电性参数(温度=25℃) Paramete (Ta=25℃)	符号 Symbol	条件 Condition	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Units
工作电压 working voltage	Vcc	--	2.7	--	5.5	V
静态电流 Supply Current	Icc	Vcc=5.0v	0.10	0.22	0.30	mA
载波频率 B.P.F. Center Frequency	fo	--	--	37.9	--	kHz
峰值波长 Peak Wavelength	λ p	--	--	940	--	nm
低电平输出 Low Level Output Voltage	Vol	--	--	0.20	0.40	mV
高电平输出 High Level Output Voltage	Voh	Vcc=5.0v	Vs-0.4	--	Vs+0.2	V
脉冲宽度 pulse width	Tpw	--	450	600	750	μ S
接收距离 Arrival Distance*1	L1	(θ =0)	16	20	--	m
	L2	(θ =30°)	10	13	--	m
半角 Half angle	2 θ 1/2	--	--	±45	--	Deg

*1、在 25 摄氏度 200Lux 环境下，MI:3 装置采用 NEC 编码，ZIR053-30 发射源，流过电流是 175mA。
 In a 200Lux environment at 25℃, the MI:3 device uses NEC code, ZIR053-30 emission source and a current of 175mA flowing through it.

方框图 Block Diagram



试验方法 Test Method

A. Standard Transmitter

ON/OFF pulse width satisfied from 25 cm to detection limit

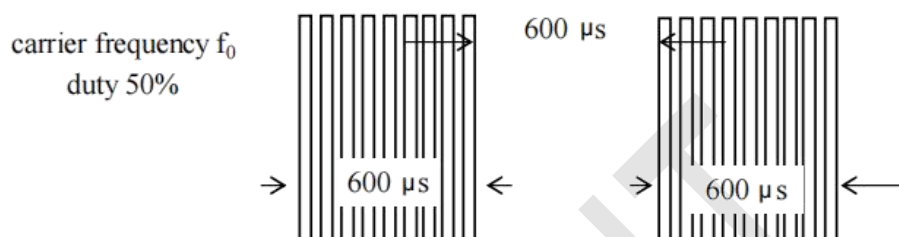


Fig 1. Burst Wave

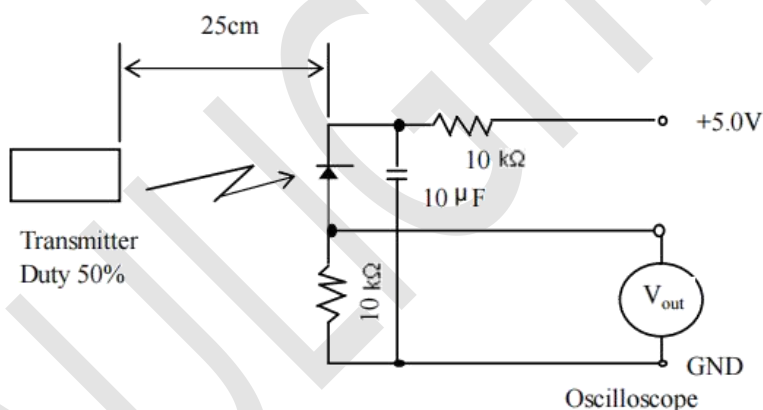
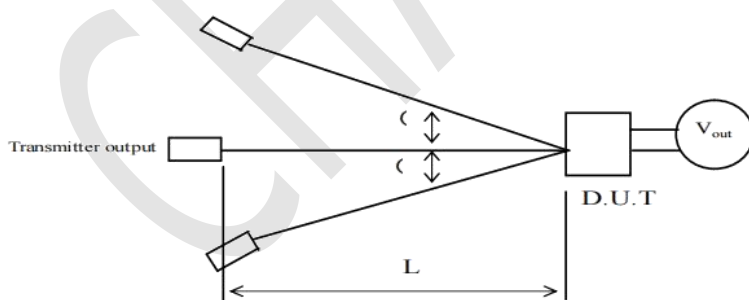


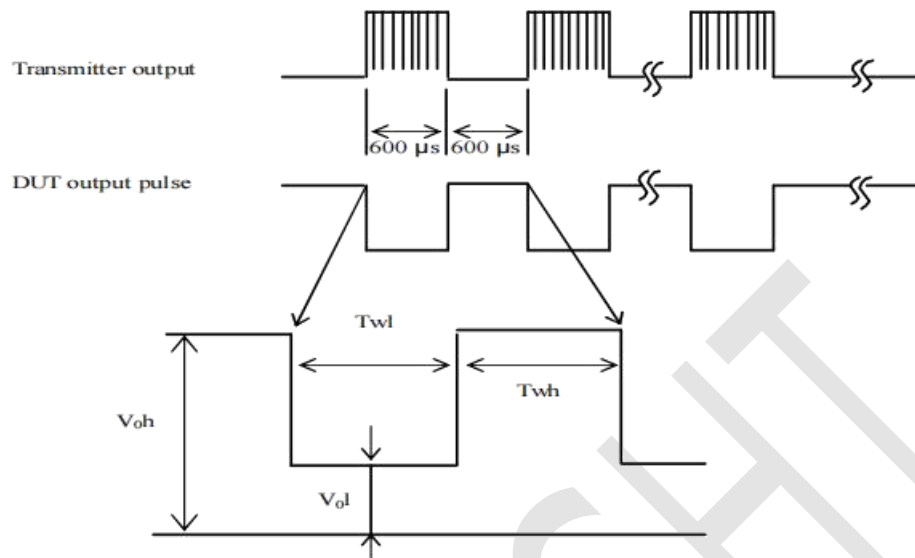
Fig 2. Standard Transmitter Measurement circuit

B. Detection Length Test

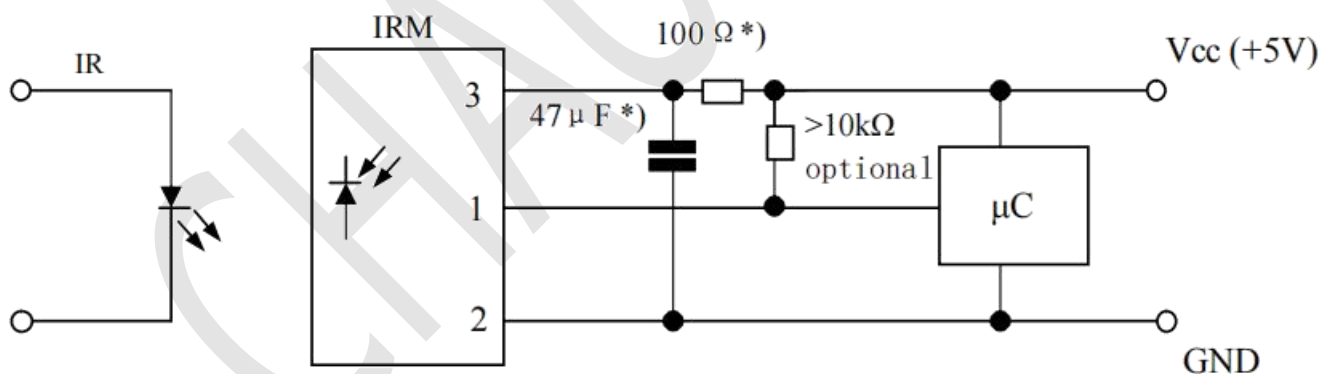


: indicates horizontal and vertical directions

C . Pulse Width Test



应用电路 Application Circuit

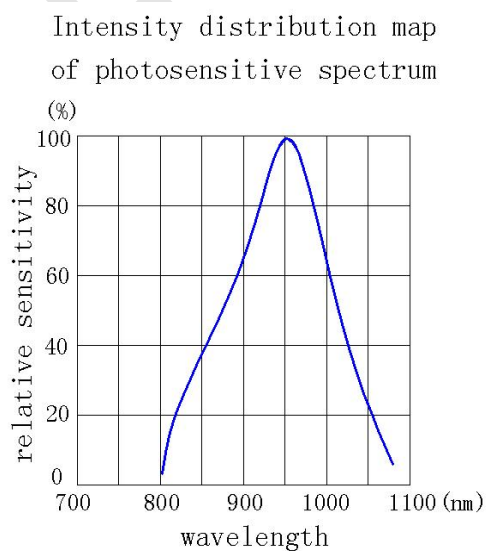
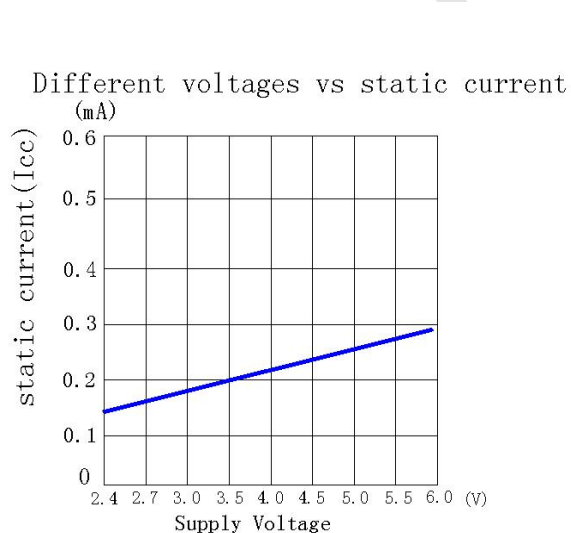


*) recommended to suppress power supply disturbances

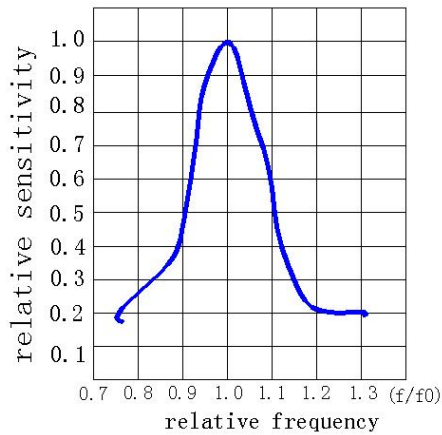
代码信息 Code information

IR Code / Noise Immunity	Acceptable
NEC	O
RC5	O
RC6	O
Toshiba	O
Sharp	O
Sony 12bit	O
Sony 15bit	O
Sony 20bit	X
Zenith	O
JVC	O
RCMM	X
Continuous Code	X

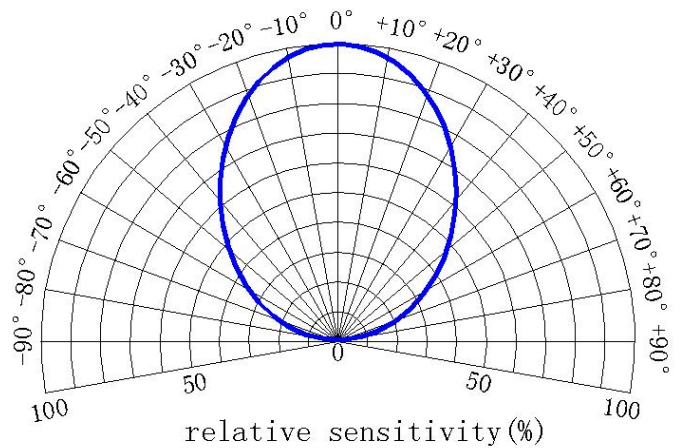
典型光电特性曲线图 Typical Electro-Optical Characteristics Curves



Carrier frequency bandwidth (-3dB)



Angular displacement θ (deg)

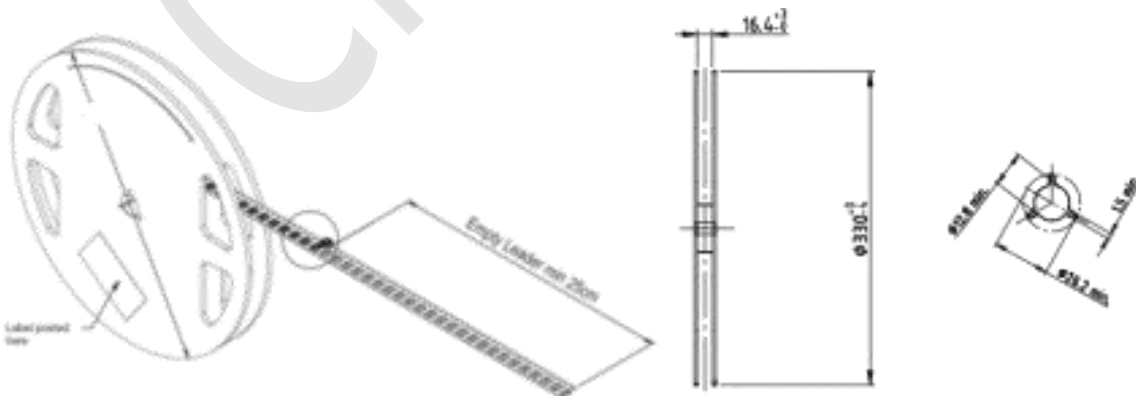


ESD Test Results 测试结果

Parameter	Specification	Results
Machine Model 机器	Min $\pm 200V$	$> \pm 400V$
Human Body Model 人类的身体	Min $\pm 2000V$	$> \pm 4000V$
Charged Device Model 带电的设备	Min $\pm 400V$	$> \pm 600V$

包装规格 Packing Specification

--卷轴包装尺寸 Package Dimensions

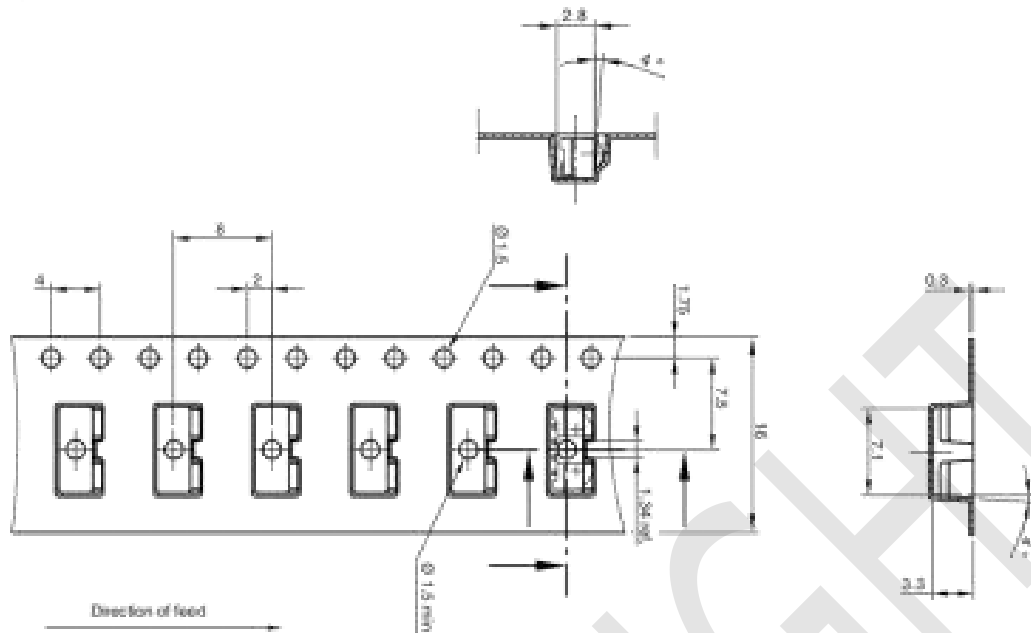


--载带编带的尺寸 Carrier Tape Dimensions

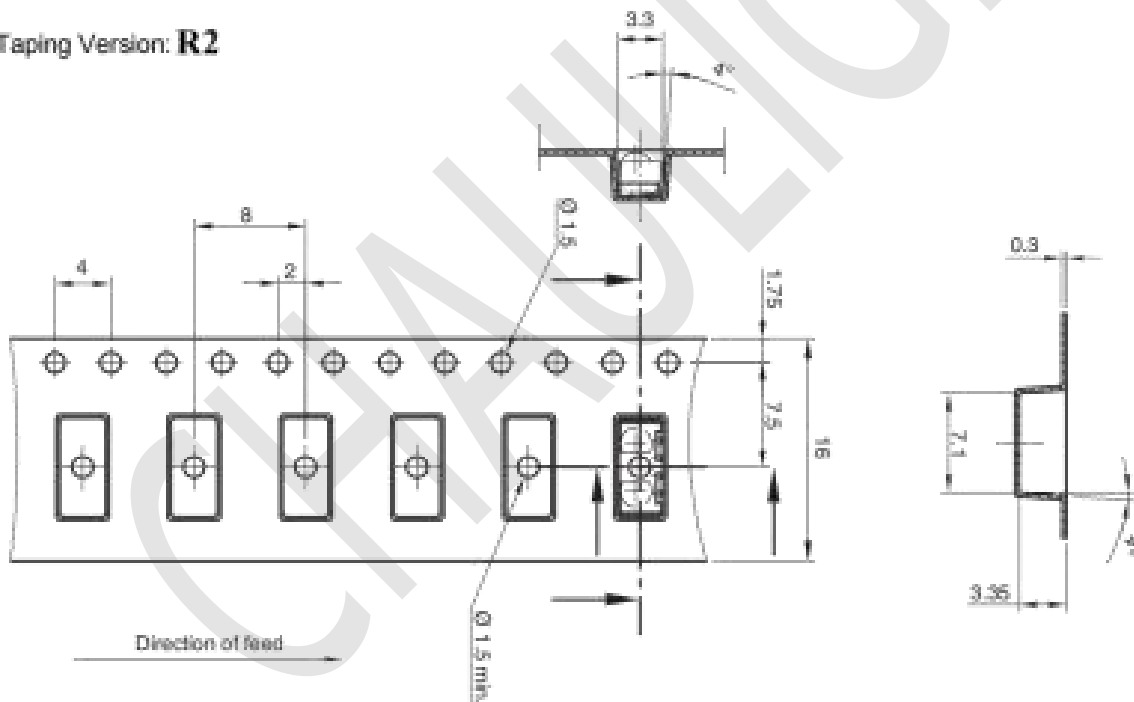
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进料方向 Progressive Direction

Taping Version: **R1**



Taping Version: **R2**



--装载数量 Loaded :

Quantity 2000 个/盘

pcs/reel

--备注 Note

所有的尺寸公差最少是正负0.1 毫米 The tolerances unless mentioned is $\pm 0.1\text{mm}$

可靠性 Reliability

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测试项目 Test item	测试条件 Test condition	适用 Standard
高温 High temperature	Ta=+80℃ t=48H	Note 2
寿命测试 Life Test	V _{CC} =5V t=500H	Note 2
低温 Low temperature	Ta=-30℃ t=48H	Note 2
温度循环 Temperature cycle	-35℃(0.5H)~+85℃(0.5H) 20cycle	Note 2
跌落 Dropping	Test devices shall be dropped 3 times naturally onto hard wooden board from a 75cm height position.	Note 2
焊接能力测试 Soldering ability test	Ta=260℃ t=5s	Note 3

NOTE 1. Distance between emitter & detector specifies maximum distance that output wave form satisfies the standard under the conditions below against the standard transmitter .

- 1)Measuring place : Indoor without extreme reflection of light .
- 2)Ambient light source: Detecting surface illumination shall be 200±50Lux under ordinary hite fluorescense lamp of no high frequency lighting.
- 3)Standard transmitter: burst wave indicated in Fig1.of standard transmitter shall be arranged to 50mVp-p under the measuring circuit specified in Fig2.

NOTE 2. (electro-optical characteristics) shall be satisfied after leaving 1 hours in the normal temperature .

NOTE 3. (electro-optical characteristics) shall be satisfied and 90% or more of the solder area is covered with solder.

》 注意事项Note

--过流保护Over-current-proof

1、客户必须应用电阻进行保护，否则会造成轻微电压偏移大电流变化（烧毁将发生）。Customer must apply resistorsforprotection, otherwiselightvoltage shiftwillcausebigcurrentchange (Burnoutwillhappen).

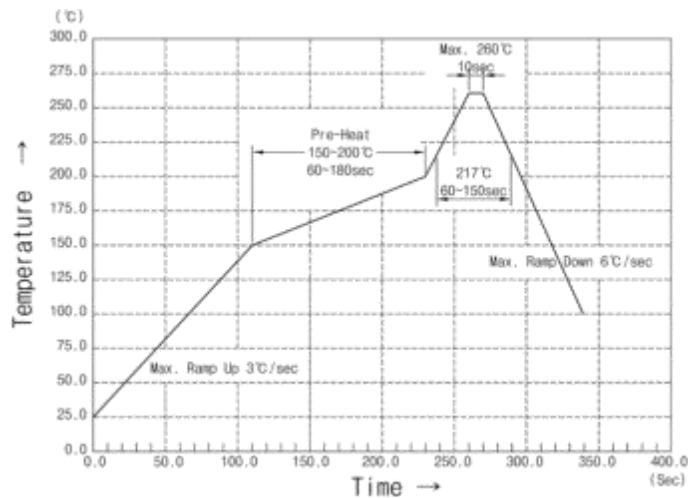
--储存Storage

- 1、产品准备使用前不要打开防潮袋。Donotopenmoistureproofbagbeforetheproductsarereadytouse.
- 2、在打开包装之前，二极管应保持在10℃~30℃和90%RH 或以下。Before opening the package, the LED shouldbe kept at 10℃~30℃and90%RH orless.
- 3、二极管建议在一年内使用。The LED suggested be used within one year.
- 4、打开包装后，设备必须存储在10℃~30℃ 和60%RH，并在168小时内使用（地板寿命）。如果未使用的二极管仍然存在，它应储存在防潮包装中。After opening the package, the devices must be storedat10℃~30℃and60%RH, and used within168 hours (floor life).IfunusedLEDremain,itshouldbestoredinmoistureproofpackages.
- 5、如果吸湿材料（干燥剂材料）已褪色或未打开的袋子已超过保质期或设备（袋外）已超过地板寿命，需要烘焙处理。Ifthemoistureabsorbentmaterial (desiccantmaterial) hasfadedorunopenedbaghasexceededthe shelflifeordeices (outofbag) haveexceededthefloorlife,bakingtreatmentisrequired.
- 6、如果需要烘焙，请参阅IPC/JEDECJ-STD-033 进行烘焙程序或建议以下条件：在60° C±5° C 和5%RH<96小时（筛/管/套单位）If baking is required, refer to IPC/JEDEC J-STD-033 forbakeprocedure orrecommend the

following conditions: 96 hours at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and $<5\%\text{RH}$ (reeled/tubed/loose units)

--焊接条件Soldering Condition

1、铅焊料温度剖面Lead solder temperature profile



2、回流焊不应做两次以上。Reflow soldering should not be done more than two times.

3、焊接时，不要在加热过程中对LED 施加压力。 When soldering, do not put stress on the LEDs during heating.

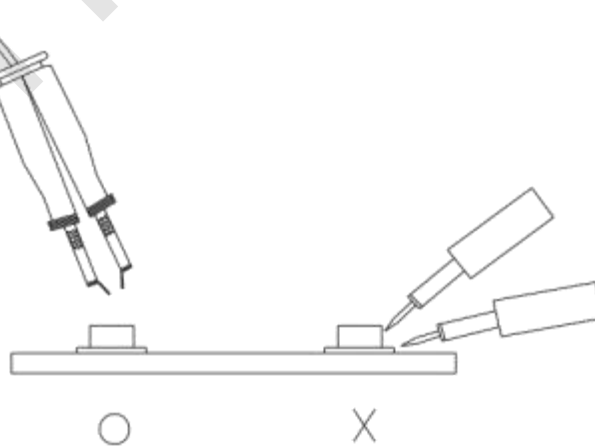
4、焊接后，不要使电路板翘曲。 After soldering, do not warp the circuit board.

--烙铁条件Soldering Iron

每个端子都要去烙铁尖端温度低于 350°C 为3 秒内一次少于烙铁功率25W。 离开两秒钟然后更多的间隔，并 做焊接每个终端。手工焊料通常在开始的时候容易损坏产品。 Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

--手工补数Repairing

修理不应在LED 焊接后进行。 当修理是不可避免的是，应该使用双头烙铁（如下图所示）。 应该是事先确认LED的特性是否会或不会损坏通过修理。 Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



--其他Other

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更改记录表 Engineering Change Notice-Record

版本 Edition	更改日期 Date	主要更改内容 Main Content	拟制 Prepared	确认 Checked
A/0	2022-08-14	新版本发布 New Edition	谢育国	郝三强